Block Diagram

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Interface Connector to
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SMA
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NOTES:
1) **DNI** = DO NOT INSTALL

**HARDWARE**

**NOTES:**
1) DNI = DO NOT INSTALL
PLACE C61 AND C62 AT DEVICE PIN.

PLACE BYPASS CAPS PER SCHEMATIC ORDER. 100pF CLOSEST TO DEVICE PIN.
PLACE BYPASS CAPS PER SCHEMATIC ORDER.
100pF CLOSEST TO DEVICE PIN.

PLACE BYPASS CAPS PER SCHEMATIC ORDER.
100pF CLOSEST TO DEVICE PIN.
NOTE: FOR ADS4449 THE FOLLOWING PINS ARE NO CONNECT PINS: E3, G3, G4, G5
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